

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Bong Jin LEE</td> <td>07/01/2013</td> </tr> <tr> <td>Yong Ho THO</td> <td>07/01/2013</td> </tr> <tr> <td>Ho Sung KIM</td> <td>07/22/2013</td> </tr> </tbody> </table>		Name	Execution Date	Bong Jin LEE	07/01/2013	Yong Ho THO	07/01/2013	Ho Sung KIM	07/22/2013		
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Ho Sung KIM	07/22/2013										
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<table border="1"> <tr> <td>Name:</td> <td>Doosan Infracore Co., Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>7-11, Hwasu-dong, Dong-gu</td> </tr> <tr> <td>City:</td> <td>Incheon</td> </tr> <tr> <td>State/Country:</td> <td>REPUBLIC OF KOREA</td> </tr> <tr> <td>Postal Code:</td> <td>401-020</td> </tr> </table>		Name:	Doosan Infracore Co., Ltd.	Street Address:	7-11, Hwasu-dong, Dong-gu	City:	Incheon	State/Country:	REPUBLIC OF KOREA	Postal Code:	401-020
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CORRESPONDENCE DATA											
<p>Fax Number: 6123343312 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Email: tsorbel@wck.com</p> <p>Correspondent Name: John D. Veldhuis-Kroeze</p> <p>Address Line 1: 900 Second Avenue South, Suite 1400</p> <p>Address Line 4: MINNEAPOLIS, MINNESOTA 55402</p>											
ATTORNEY DOCKET NUMBER:	D297.12-0081/JVK										
NAME OF SUBMITTER:	Theresa R. Sorbel										
Signature:	/Theresa R. Sorbel/										
Date:	08/30/2013										

OP \$40.00 13997536

Total Attachments: 6

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ASSIGNMENT

FOR PRIORITY APPLICATION ENTERING UNITED STATES

WHEREAS, we, LEE, Bong Jin; THO, Yong Ho and KIM, Ho Sung (hereinafter referred to as ASSIG NORS), am the sole inventor of an invention described in:

- Korean Patent Application No. 10-2010-0134627, filed on December 24 2010;
- International application for Letters Patent filed pursuant to the Patent Cooperation Treaty and designating the United States, and being identified by Application No. PCT/KR2011/010103, filed on December 26, 2011;
- any United States Patent Application claiming priority from the above-identified Korean and/or International patent application, the United States patent application being identifiable in the United States Patent and Trademark Office by Application No. 13/997,536, filed June 24, 2013;

WHEREAS, DOOSAN INFRACORE CO., LTD. (hereinafter referred to as ASSIGNEE), a Korean Limited liability company organized and existing under the laws of the Republic of Korea, and having a place of business at 7-11 Hwasu-don, Dong-gu, Incheon 401-020 Republic of Korea, is desirous of acquiring the entire right, title and interest in and to the invention, the application and any and all Letters Patent(s) or similar legal protection, foreign or domestic, to be obtained therefor;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, I transfer to Assignee, its successors and assigns, my entire right, title and interest in and to the invention, the above-identified application, all inventions and improvements which are disclosed in the patent applications, all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent(s) which have been or shall be filed in the United States on any of said inventions and/or improvements, all rights of priority resulting from the filing of the above-identified patent application(s), and all Letters Patent or similar legal protection issuing thereon; and I authorize the Director of the United States Patent and Trademark Office to issue the Letters Patent or similar legal protection to the Assignee.

I authorize the Assignee, its successors and assigns, to insert in this instrument the filing date and serial number of the application when ascertained.

I authorize the Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent or similar legal protection, in its own name if desired, in any and all countries.

I represent to the Assignee, its successors and assigns, that I have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. I, my executors or administrators, will at any time upon request, without additional consideration, but at the expense of the Assignee, its successors and assigns, execute such additional writings and do such additional acts as the Assignee, its successors and assigns, may deem desirable to perfect its enjoyment of this grant, and render all assistance in making application for and obtaining, maintaining, and enforcing the Letters Patent or similar legal protection on the invention in any and all countries.

LEE, BONGJIN
Signature of Inventor

Date : JUL. 01. 2013

LEE, Bong Jin
Printed Name of Inventor

Residence of Inventor:
104-1101 Sinmyeong Skyview Apt. Wanggil-dong,
Seo-gu Incheon 404-290 Republic of Korea

[Signature]
Signature of Witness

Date : July 1, 2013

CHO, Yoon Hee
Printed Name of Witness

Residence of Witness:
15th Fl. Gusegun Bldg. 7 Chungjeongro
Seodaemun-gu, Seoul 120-013
Republic of Korea

Signature of Inventor

Date : _____

THO, Yong Ho

Printed Name of Inventor

Residence of Inventor:

101-1803 Dansan Prugio Apt. Yeongdeungpo-dong 8-ga,
Yeongdeungpo-gu Seoul 150-920

Republic of Korea

Signature of Witness

Date : _____

CHO, Yoon Hee

Printed Name of Witness

Residence of Witness:

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Seodaemun-gu, Seoul 120-013

Republic of Korea

Signature of Inventor

Date : _____

KIM, Ho Sung

Printed Name of Inventor

Residence of Inventor:

302 153-33 Maetan 1-dong, Yeongtong-gu,
Suwon-si Gyeonggi-do 443-371

Republic of Korea

Signature of Witness

Date : _____

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Signature of Inventor

Signature of Witness

Date :

Date :

LEE, Bong Jin

CHO, Yoon Hee

Printed Name of Inventor

Printed Name of Witness

Residence of Inventor:

Residence of Witness:

104-1101 Sinmyeong Skyview Apt. Wanggil-dong,

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Seodaemun-gu, Seoul 120-013

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THO YONG HO
Signature of Inventor

Date : JUL. 01. 2013

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CHO
Signature of Witness

Date : July 1. 2013

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Printed Name of Witness

Residence of Witness:

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Republic of Korea

Signature of Inventor

Date : _____

KIM, Ho Sung
Printed Name of Inventor

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302 153-33 Maetan 1-dong, Yeongtong-gu,
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Signature of Witness

Date : _____

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LEE, Bong Jin

CHO, Yoon Hee

Printed Name of Inventor

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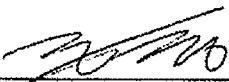
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Signature of Inventor


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Date : July 22, 2013

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